

# CRMKGL0602A

N-Channel 60V, 2.4mΩ Typ. Power MOSFET

### **Description**



• 60V, 138A

 $R_{DS(ON)}$  Typ = 2.4m $\Omega$  @ V<sub>GS</sub> = 10V

 $R_{DS(ON)}$  Typ = 3m $\Omega$  @ V<sub>GS</sub> = 4.5V

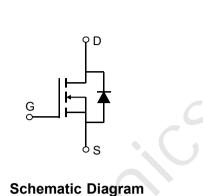
- Advanced Split Gate Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

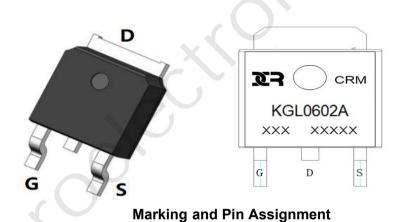
**Application** 

PWM Application

• Power Management

· Load Switch



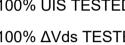


## Package Marking and Ordering Information

Device	e Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)		
CRMKGL06	602A CRMKGL0602A	TO-252-3L	TAPING	13"	2500	25000		

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V <sub>DS</sub>	Drain-to-Source Voltage		60	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	$T_c = 25^{\circ}C$	138	А
Ι <sub>D</sub>		T <sub>C</sub> = 100°C	82.8	А
I <sub>DM</sub>	Pulsed Drain Current <sup>(1)</sup>		552	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy <sup>(2)</sup>		333	mJ
P <sub>D</sub>	Power Dissipation	$T_c = 25^{\circ}C$	104	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
Τ <sub>J</sub> , Τ <sub>stg</sub>	Junction & Storage Temperature Range		-55 to 150	°C





#### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	60	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	-	-	1.0	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				G	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.8	2.4	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(3)</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A	-	2.4	3.1	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A	-	3	3.9	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance		-	4470	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 30V, f = 1MHz	Χ-	1096	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 110112	-	14	-	pF
Qg	Total Gate Charge	0	<u> </u>	65	-	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 30V$ , $I_{D} = 50A$	-	28	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v$ , $v_{\rm D} = 30 A$	-	4	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime		-	16	-	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 30V	-	30	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_{D}$ = 50A, $R_{GEN}$ = 2.7 $\Omega$	-	43	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	18	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I <sub>s</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	138	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	552	А
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 30A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	43	-	ns
Qrr	Body Diode Reverse Recovery Charge	I <sub>F</sub> = 50A, di/dt = 100A/us	-	50	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2.  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =30V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =36.5A

3. Pulse Test: Pulse Width $\leq$ 300µs, Duty Cycle $\leq$ 0.5%.



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### **Test Circuit**

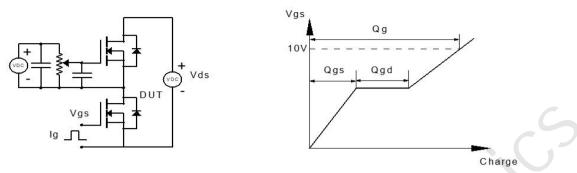
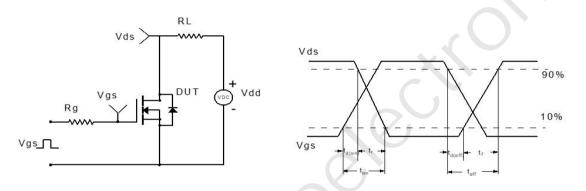
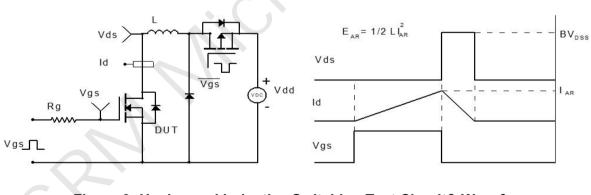


Figure 1: Gate Charge Test Circuit & Waveform



#### Figure 2: Resistive Switching Test Circuit & Waveform



#### Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

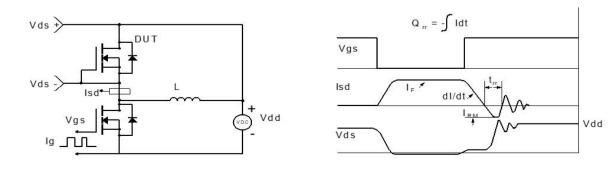
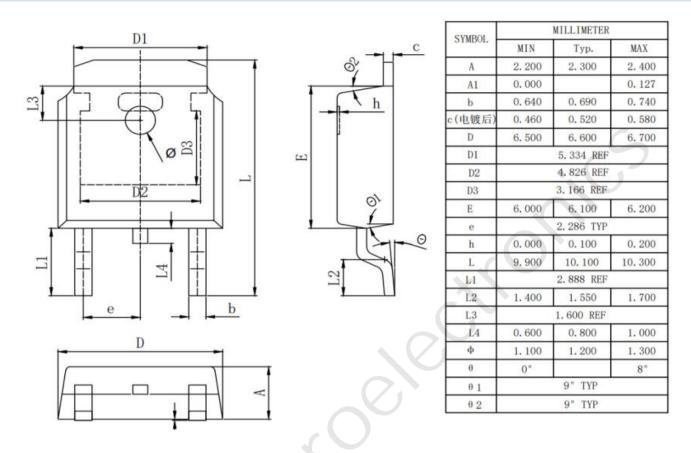


Figure 4: Diode Recovery Test Circuit & Waveform



## Package Mechanical Data(TO-252-3L)



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## **Contact information**

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